TOSHIBA 2SK2698

TOSHIBA FIELD EFFECT TRANSISTOR SILICON N CHANNEL MOS TYPE (π -MOS V)

2 S K 2 6 9 8

HIGH SPEED, HIGH VOLTAGE SWITCHING APPLICATIONS DC-DC CONVERTER, RELAY DRIVE AND MOTOR DRIVE APPLICATIONS

Low Drain-Source ON Resistance : $R_{DS(ON)} = 0.35 \Omega$ (Typ.)

High Forward Transfer Admittance : $|Y_{fS}| = 11 \text{ S}$ (Typ.)

Low Leakage Current : $I_{DSS} = 100 \,\mu\text{A}$ (Max.) ($V_{DS} = 500 \,\text{V}$)

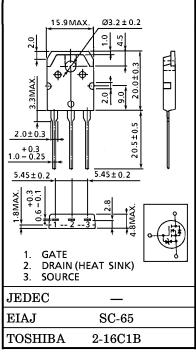
Enhancement-Mode : $V_{th} = 2.0 \sim 4.0 \text{ V}$

 $(V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA})$

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERIST	SYMBOL	RATING	UNIT	
Drain-Source Voltage	$v_{ m DSS}$	500	V	
Drain-Gate Voltage (RGS	$v_{ m DGR}$	500	V	
Gate-Source Voltage	v_{GSS}	± 30	V	
Drain Current	DC	$I_{\mathbf{D}}$	15	Α
	Pulse	I_{DP}	60	Α
Drain Power Dissipation	$P_{\mathbf{D}}$	150	W	
Single Pulse Avalanche	EAS	630	mJ	
Avalanche Current	$I_{ m AR}$	15	Α	
Repetitive Avalanche En	E_{AR}	15	mJ	
Channel Temperature	$\mathrm{T_{ch}}$	150	$^{\circ}\mathrm{C}$	
Storage Temperature Range		$\mathrm{T_{stg}}$	-55~150	°C

INDUSTRIAL APPLICATIONS Unit in mm



Weight: 4.6 g

THERMAL CHARACTERISTICS

	SYMBOL		
Thermal Resistance, Channel to Case	$R_{th (ch-c)}$	0.833	°C/W
Thermal Resistance, Channel to Ambient	R _{th (ch-a)}	50	°C/W

Note:

* Repetitive rating; Pulse Width Limited by Max. junction temperature.

** $V_{DD} = 90 \text{ V}, T_{ch} = 25^{\circ}\text{C}$ (initial), $L = 4.76 \text{ mH}, R_{G} = 25 \Omega, I_{AR} = 15 \text{ A}$

This transistor is an electrostatic sensitive device. Please handle with caution.

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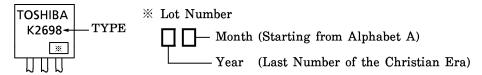
ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARAC	TERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage	Current	$I_{ m GSS}$	$V_{GS} = \pm 25 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±10	μ A
Gate-Source B Voltage	reakdown	V (BR) GSS	$I_{G} = \pm 10 \mu\text{A}, V_{DS} = 0 \text{V}$	±30	_	_	v
Drain Cut-off	Current	$I_{ m DSS}$	$V_{DS} = 500 \text{ V}, \ V_{GS} = 0 \text{ V}$	_	_	100	μ A
Drain-Source 1 Voltage	Breakdown	V (BR) DSS	$I_D = 10 \text{ mA}, \text{ V}_{GS} = 0 \text{ V}$	500	_	_	V
Gate Threshol	d Voltage	$V_{ m th}$	$V_{DS} = 10 \text{ V}, I_D = 1 \text{ mA}$	2.0	_	4.0	V
Drain-Source	ON Resistance	R _{DS} (ON)	$V_{GS} = 10 \text{ V}, I_{D} = 7.0 \text{ A}$	_	0.35	0.4	Ω
Forward Trans Admittance	sfer	Y _{fs}	$V_{DS} = 10 \text{ V}, I_D = 7.0 \text{ A}$	6	11	_	S
Input Capacita	ance	$\mathrm{c}_{\mathrm{iss}}$		_	2600	_	
Reverse Transfer Capacitance		C_{rss}	$V_{ m DS} = 10 m V, \ V_{ m GS} = 0 m V, \ f = 1 MHz$	_	280	_	рF
Output Capaci	itance	Coss		_	880	_	
Switching Time Fall	Rise Time	t_r	$V_{GS} \stackrel{10 \text{ V}}{\circ} V \stackrel{I_D = 7 \text{ A}}{\circ} V_{OUT}$ $R_L = 30 \Omega$ $V_{DD} = 210 \text{ V}$	_	50	_	
	Turn-on Time	t_{on}		-	85	_	ns
	Fall Time	t_f		1	65	_	ns
	Turn-off Time	$t_{ m off}$	$V_{ ext{IN}}: ext{t}_{ ext{r}}, ext{t}_{ ext{f}} < 5 ext{ ns,} \ ext{Duty} \leq 1\%, ext{t}_{ ext{W}} = 10 ext{ } \mu ext{s}$	_	260	_	
Total Gate Charge (Gate- Source Plus Gate-Drain)		$\mathbf{Q}_{\mathbf{g}}$	$V_{DD} = 400 \text{ V}, V_{GS} = 10 \text{ V},$	_	58	_	nC
Gate-Source Charge		$\mathbf{Q}_{\mathbf{g}\mathbf{s}}$	$I_{\mathrm{D}}=15~\mathrm{A}$	_	36	_	110
Gate-Drain ("Miller") Charge		$\mathbf{Q}_{\mathbf{gd}}$		_	22	_	

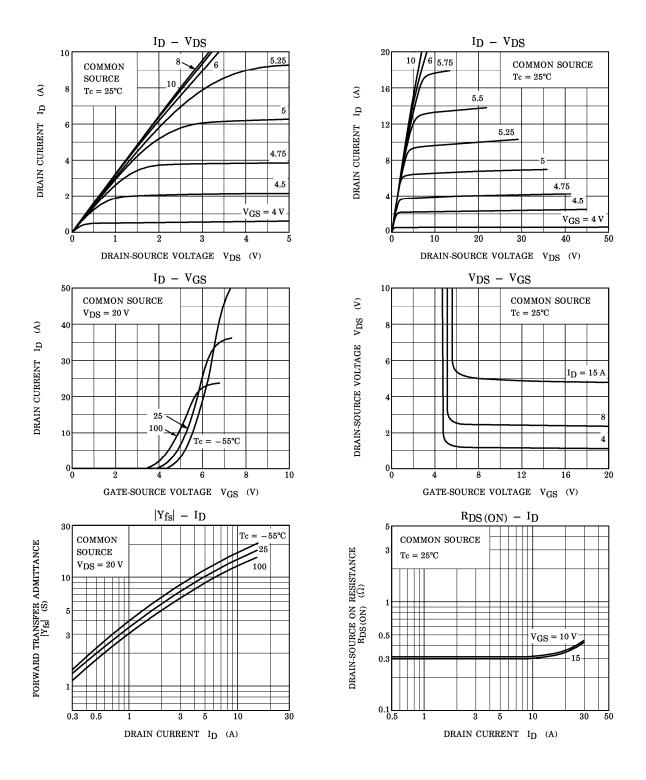
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (Ta = 25°C)

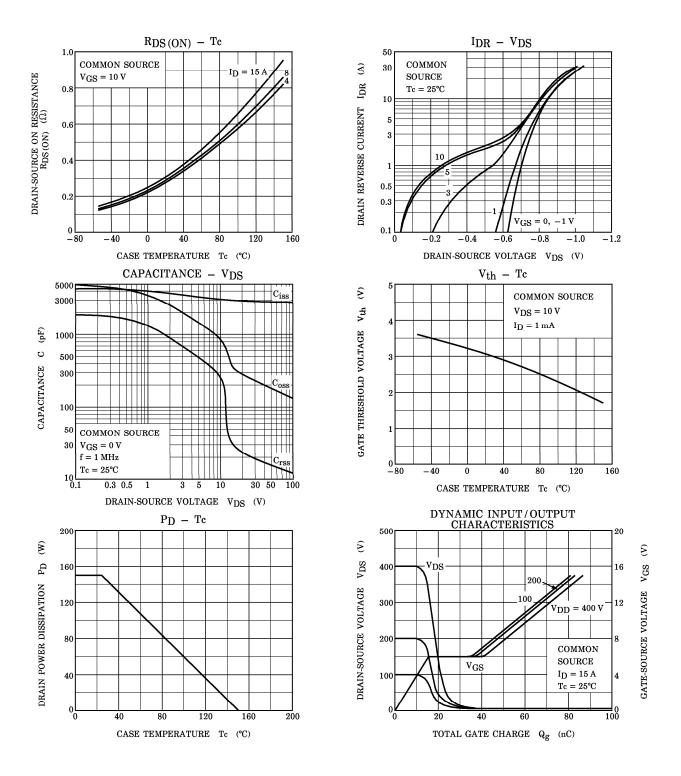
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Continuous Drain Reverse Current	$I_{ m DR}$	_	_	_	15	A
Pulse Drain Reverse Current	$I_{ m DRP}$	_	_	_	60	A
Diode Forward Voltage	$V_{ m DSF}$	$I_{DR} = 15 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.7	V
Reverse Recovery Time	${ m t_{rr}}$	$I_{DR} = 15 \text{ A}, V_{GS} = 0 \text{ V}$	_	400	_	ns
Reverse Recovery Charge	Q_{rr}	$\mathrm{dI}_{\mathrm{DR}}$ / $\mathrm{dt}=100\mathrm{A}$ / $\mu\mathrm{s}$	_	4.3	_	μ C

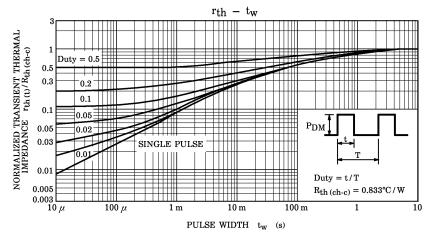
MARKING

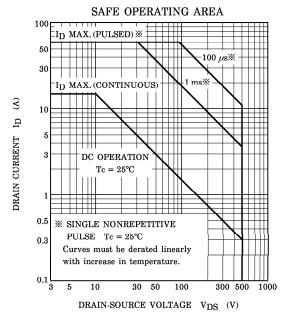


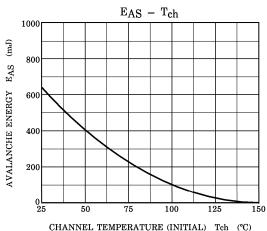
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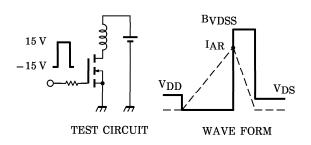












$$\begin{array}{l} Peak~I_{AR}=15~A,~R_G=25~\Omega \\ V_{DD}=90~V,~L=4.76~mH \end{array}~E_{AS}=\frac{1}{2}\cdot L~\cdot I^2\cdot (~\frac{BVDSS}{BVDSS-V_{DD}}) \label{eq:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equation:equatio$$